

DISTINCTIVE CHARACTERISTICS

Compact Size Combined with High Resolution

- High resolution of 64 x 32 pixels
- 64 colors of backlighting can be controlled dynamically
- Pushbutton switch with LCD, RGB LED backlighting
- General brightness of backlight is dynamically controlled in eight steps from dark to bright
- Operated by commands and data supplied via serial communications (SPI)
- Can display as many as four lines of text with ten characters each
- Incorporates bitmap display function
- Programmable display graphics for alphanumeric characters and animated sequences
- Dual image VRAM for quick change of displayed images
- Low energy consumption
- Dust tight construction

Viewing area: 14.5mm x 11.8mm (horizontal x vertical)

Variety of LED backlighting with 64 colors and 8 steps brightness

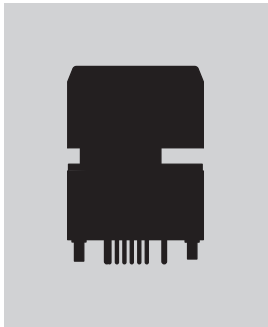
Dome gives crisp tactile feedback to positively indicate circuit transfer

Epoxy sealed straight PC terminals

Snap-in standoff for easy, secure mounting and alignment



Actual Size



PART NUMBER & DESCRIPTION

Part Number	Switch Description	LCD Mode	LED Color
IS15ESBFP4RGB	SPST Momentary ON Gold Contacts Straight PC Terminals	Black & White FSTN Positive	Red/Green/Blue

4.1.15

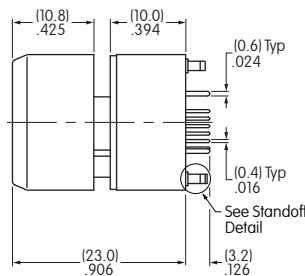
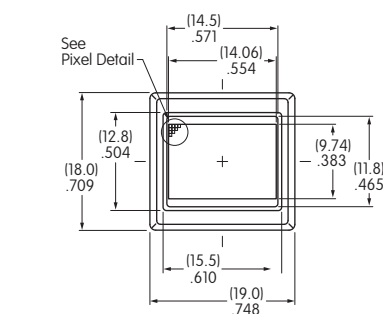


IS15ESBFP4RGB
RGB LED Backlight
Black and White LCD

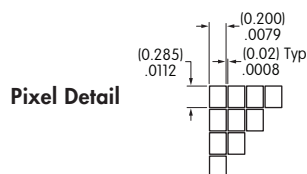
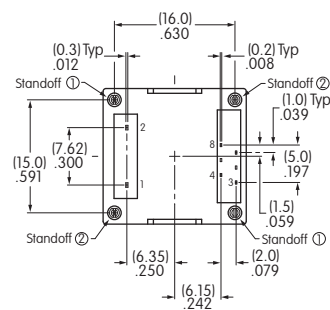
SWITCH SPECIFICATIONS

Circuit	SPST normally open
Electrical Capacity (Resistive Load)	100mA @ 12V DC
Contact Resistance	200 milliohms maximum @ 20mV 10mA
Insulation Resistance	100 megohms minimum @ 100V DC
Dielectric Strength	125V AC for 1 minute minimum
Mechanical Endurance	1,000,000 operations minimum
Electrical Endurance	1,000,000 operations minimum
Operating Force	1.7 ± 0.5 Newtons
Total Travel	1.8mm (.177")

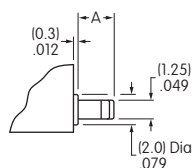
TYPICAL SWITCH DIMENSIONS



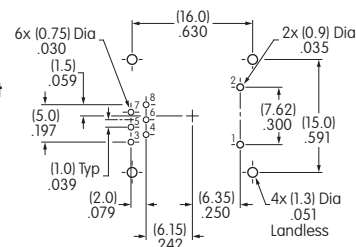
Terminal numbers are not on the switch.



Standoff Detail



Footprint



Dimension A

Standoff 1 = (2.7) .106 Standoff 2 = (2.3) .091

LCD SPECIFICATIONS

Characteristics of Display

Display Operation Mode	FSTN positive; background colors, black & white
Display Condition	Transflective with built-in LED backlight
Viewing Angle Direction	6 o'clock
Viewing Area	14.5mm x 11.8mm (horizontal x vertical)
Pixel Format	64 x 32 pixels (horizontal x vertical)
Pixel Size	0.200mm x 0.285mm (horizontal x vertical)
* Operating Temperature Range	-15°C ~ +50°C (+5°F ~ +122°F)
Storage Temperature Range	-20°C ~ +60°C (-4°F ~ +140°F)
Backlight LED	RGB: red/green/blue

* In a low temperature environment (below 0°C), speed and contrast decrease when image changes. The non-indicator dot may become dense in a high temperature environment (about +50°C). Highest backlight brightness level should not be used for temperatures above +35°C.

Absolute Maximum Ratings (Temperature at 25°C)

Items	Symbols	Ratings
Supply Voltage	V_{DD}	-0.3V to +7.0V
Input Voltage	V_I	-0.3V to $V_{DD} + 0.3V$
Output Voltage	V_O	-0.3V to $V_{DD} + 0.3V$

Optical Characteristics (Temperature at 25°C)

Items	Symbols	Min	Typical	Max
Contrast Ratio	Cr	—	3.0	—
Viewing Angle (Cr ≥ 1.1)	Up & Down	θ	90°	—
	Right & Left	φ	90°	—

Recommended Operating Conditions (Temperature at 25°C)

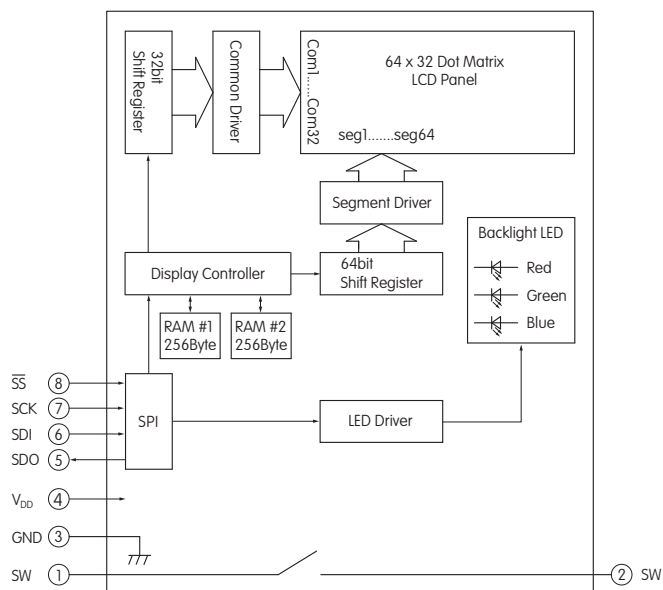
Items	Symbols	Minimum	Typical	Maximum
Supply Voltage	V_{DD}	4.9V	5.0V	5.1V
High Level Input Voltage	V_{IH}	0.8 V_{DD}	—	—
Low Level Input Voltage	V_{IL}	—	—	0.2 V_{DD}
SPI Clock Frequency	f_{SCK}	—	—	8MHz
Current Consumption	I_{DD}	** 10mA	—	*** 60mA

** 10mA: Backlighting LED is off

*** 60mA: Backlighting LEDs (Red, Green, Blue) are maximum brightness

BLOCK DIAGRAM & PIN CONFIGURATIONS

Pin No.	Symbol	Name	Function
①	SW	Terminal of Switch	Normally open
②	SW	Terminal of Switch	Normally open
③	GND	Ground	
④	V _{DD}	Power	Power source for logic circuit and LCD
⑤	SDO	Data Out	Data output line for SPI
⑥	SDI	Data In	Data input line for SPI
⑦	SCK	Serial Clock	Clock line for SPI that synchronizes commands and data
⑧	$\overline{SS}$	Slave Select	Chip select for SPI; line is active low



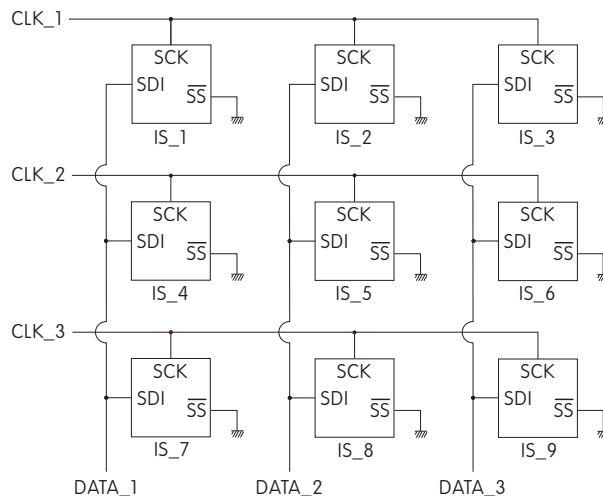
TIMING SPECIFICATIONS

SPI Characteristics (See Timing Diagram)

(Temperature at -15°C ~ +50°C and V_{DD} = 5.0V ± 2%)

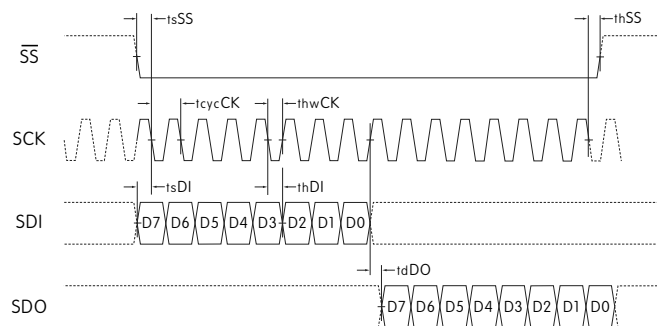
Items	Symbols	Minimum	Maximum
SPI $\overline{SS}$ Set Up Time	t_{sSS}	10ns	
SPI $\overline{SS}$ Hold Time	t_{hSS}	10ns	
SPI_CLK Cycle	t_{cycCK}		8MHz
SPI_CLK Width	t_{hwCK}	10ns	
SPI_DI Set Up Time	t_{sDI}	10ns	
SPI_DI Hold Time	t_{hDI}	10ns	
SPI_DO Delay Time	t_{dDO}	10ns	

Circuit Example

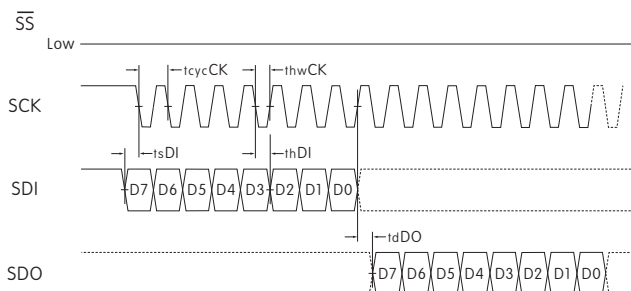


It is recommended that all $\overline{SS}$ pins be connected to a controller pin instead of ground. A clock glitch during power up could cause the communication to fall out of sync. Toggling the $\overline{SS}$ line resets the communication.

SPI Timing Chart ($\overline{SS}$ Using)



SPI Timing Chart ($\overline{SS}$ Low Level Fixed)



SDI and SCK shall be kept high when idle.

Segment	
Common	1 2 3 4 5 6 7 8 9 • • • 16 • • • • 49 • • • 56 57 58 59 60 61 62 63 64
COM1	Byte8 Byte7 • • • Byte2 Byte1 D0 D1 D2 D3 D4 D5 D6 D7 D0 • • • D7 • • • D0 • • • D7 D0 D1 D2 D3 D4 D5 D6 D7
	Byte16 Byte9 D0 D1 D2 D3 D4 D5 D6 D7 D0 D1 D2 D3 D4 D5 D6 D7
	• • •
COM2	Byte256 • • • Byte249 D0 D1 D2 D3 D4 D5 D6 D7 D0 D1 D2 D3 D4 D5 D6 D7
	• • •
	• • •
COM32	Byte8 Byte7 • • • Byte2 Byte1 D0 D1 D2 D3 D4 D5 D6 D7 D0 • • • D7 • • • D0 • • • D7 D0 D1 D2 D3 D4 D5 D6 D7
	Byte16 Byte9 D0 D1 D2 D3 D4 D5 D6 D7 D0 D1 D2 D3 D4 D5 D6 D7
	• • •

Command		Data (256 Bytes)																														
0 x 55		Byte1								Byte2 • • • Byte255								Byte256														
0	1	0	1	0	1	0	1	0	1	D7	D6	D5	D4	D3	D2	D1	D0	D7	D6	•	•	•	D1	D0	D7	D6	D5	D4	D3	D2	D1	D0

Command		Data	Remarks
Hex	Binary		
0 x 55	01010101	256 Bytes (64 x 32 = 2,048 bits)	See above for details of bitmap data

Command		Data	Remarks	
Hex	Binary			
0 x 40	01000000	R R G G B B 1 1 2 bits x 3	For each of RGB: 00 = off 10 = 1/2 01 = 1/4 11 = full	

Command		Data	Remarks
Hex	Binary		
0 x 41	01000001	* * * 1 1 1 1 1 3 bits	For leading 3bits: 000 = 1/20 (dark) 100 = 1/3 001 = 1/10 101 = 1/2 010 = 1/7 110 = 2/3 011 = 1/5 111 = full (bright)

Command		Data	Remarks
Hex	Binary		
0 x 5E	01011110	00000011	Returning to initial status at power activation

PRECAUTIONS FOR HANDLING & STORAGE OF LCD 64 x 32 DEVICES**Handling**

1. The IS Series devices are electrostatic sensitive.
2. Limit operating force to keytop to 100.0N maximum, as excessive pressure may damage the LCD device.
3. The IS series devices are not process sealed.
4. If the LCD is accidentally broken, avoid contact with the liquid and wash off any liquid spills to the skin or clothing.
5. Clean cap surface with dry cloth. If further cleaning is needed, wipe with dampened cloth using neutral cleanser and dry with clean cloth. Do not use organic solvent.
6. Recommended soldering time and temperature limits:
Do not exceed 60°C at the LCD level.
Wave Soldering: see Profile B in Supplement section.
Manual Soldering: see Profile A in Supplement section.
7. Excessive images may result after the same image is emitted continuously for an extended period of time.
8. The highest backlight brightness level should not be used for temperatures above +35°C.

Storage

1. Store in original container and away from direct sunlight.
2. Keep away from static electricity.
3. Avoid extreme temperatures, high humidity, gaseous substances, and all forms of chemical contamination.